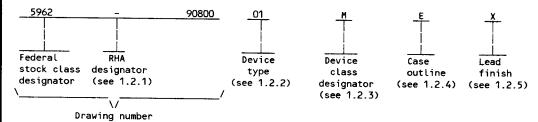
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DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

5962-E429

## 1. SCOPE

- 1.1 <u>Scope</u>. This drawing forms a part of a one part one part number documentation system (see 6.6 herein). Two product assurance classes consisting of military high reliability (device classes B, Q, and M) and space application (device classes S and V), and a choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). Device class M microcircuits represent non-JAN class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices". When available, a choice of radiation hardness assurance (RHA) levels are reflected in the PIN.
  - 1.2 PIN. The PIN shall be as shown in the following example:



- 1.2.1 <u>Radiation hardness assurance (RHA) designator</u>. Device classes M, B, and S RHA marked devices shall meet the MIL-M-38510 specified RHA levels and shall be marked with the appropriate RHA designator. Device classes Q and V RHA marked devices shall meet the MIL-I-38535 specified RHA levels and shall be marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.
  - 1.2.2 <u>Device type(s)</u>. The device type(s) shall identify the circuit function as follows:

Device type	Generic number	Circuit function	Clock <u>frequency</u>
01	54L\$502	8-bit successive approximation registe	25 MHz

1.2.3 <u>Device class designator</u>. The device class designator shall be a single letter identifying the product assurance level as follows:

Device class	Device requirements documentation
М	Vendor self-certification to the requirements for non-JAN class B microcircuits in accordance with 1.2.1 of MIL-STD-883
B or S	Certification and qualification to MIL-M-38510
Q or V	Certification and qualification to MIL-I-38535

1.2.4 <u>Case outline(s)</u>. For device classes M, B, and S, case outline(s) shall meet the requirements in appendix C of MIL-M-38510 and as listed below. For device classes Q and V, case outline(s) shall meet the requirements of MIL-I-38535, appendix C of MIL-M-38510, and as listed below.

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
E F	GDIP1-T16 or CDIP2-T16 GDFP2-F16 or CDFP3-F16	16 14	Dual-in-line package
•	901-5-110 OL CD12-110	16	Flat package

1.2.5 <u>Lead finish</u>. The lead finish shall be as specified in MIL-M-38510 for classes M, B, and S or MIL-I-38535 for classes Q and V. Finish letter "X" shall not be marked on the microcircuit or its packaging. The "X" designation is for use in specifications when lead finishes A, B, and C are considered acceptable and interchangeable without preference.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-90800
		REVISION LEVEL	SHEET 2

D	DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444  REVISION LEVEL SHEET 3						
	STANDARDIZED MILITARY DRAWING	SIZE A		5962-90800			
<u>3</u> / Valu	es will be added when they become available.						
	·	, c.a., tos.					
maxi	mum levels may degrade performance and affect relia with stand the added ${\sf P}_{\sf D}$ due to the short circuit te	bility.	activet provinced o	perworm Mt till			
<u>1</u> / Stre	esses above the absolute maximum rating may cause pe	ermanent damage to	o the device. Extended o	peration at the			
	MIL-BUL-103 - List of Standardized M	ntitary Drawings	(SMD's).				
		id i de anno e Porto de la constanta de la con	(OMD L-)				
BUL	MILITARY						
BIII	LETIN	ines.					
	MIL-STD-480 - Configuration Control- MIL-STD-883 - Test Methods and Proce MIL-STD-1835 - Microcircuit Case Outl	dures for Microel	ges, Deviations and Waive Lectronics.	rs.			
	MILITARY						
STA	INDARDS						
	MIL-M-38510 - Microcircuits, General MIL-I-38535 - Integrated Circuits, M		or. neral Specification for.				
	MILITARY						
SPE	CIFICATIONS						
specific	overnment specifications, standards, bulletin, and actions, standards, bulletin, and handbook of the is fications and Standards specified in the solicitati	sue listed in tha	at issue of the Departmen	t of Defense Index			
2. AP	PLICABLE DOCUMENTS						
	Fault coverage measurement of manufacturing logic tests (MIL-STD-883, test method 5012)	<u>3</u> /					
1.5	Digital logic testing for device classes Q and V.						
	Supply voltage range ( $V_{CC}$ ) Minimum high level input voltage ( $V_{IH}$ ) Maximum low level input voltage ( $V_{II}$ ) Maximum high level output current ( $I_{OL}$ ) Ambient operating temperature range ( $I_A$ )	+4.5 V d - 2.0 V d - 0.7 V d4.0 mA 4.0 mA d55°C td	dc dc				
1.4	Recommended operating conditions.	. / 5	da da 15 5 V 1				
	Supply voltage ( $V_{CC}$ ) +7.0 V dc Input voltage ( $V_{IN}$ ) +7.0 V dc Thermal resistance, junction-to-case ( $\Theta_{JC}$ ) See MIL-STD-1835 Junction temperature ( $T_J$ ) +175°C Storage temperature						
	Supply voltage (V <sub>CC</sub> )	- +7.0 V d					
1.3	Absolute maximum ratings. 1/						
1.3	Absolute maximum ratings. 1/ Supply voltage (V <sub>CC</sub> )	- +7.0 V c					

## HANDBOOK

MILITARY

MII -HDBK-780

- Standardized Military Drawings.

(Copies of the specifications, standards, bulletin, and handbook required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

## 3. REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements for device class M shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein. The individual item requirements for device classes B and S shall be in accordance with MIL-M-38510 and as specified herein. For device classes B and S, a full electrical characterization table for each device type shall be included in this SMD. The individual item requirements for device classes Q and V shall be in accordance with MIL-I-38535, the device manufacturer's Quality Management (QM) plan, and as specified herein.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 for device classes M, B, and S and MIL-I-38535 for device classes Q and V and herein.
  - 3.2.1 <u>Case outline(s)</u>. The case outline(s) shall be in accordance with 1.2.4 herein.
- 3.2.2 <u>Terminal connections and descriptions</u>. Terminal connections and descriptions shall be as specified on figure 1.
  - 3.2.3 Truth table. The truth table shall be as specified on figure 2.
  - 3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.
- 3.2.5 <u>Test circuit and switching waveforms</u>. The test circuit and switching waveforms shall be as specified on figure 4.
- 3.3 <u>Electrical performance characteristics and postirradiation parameter limits</u>. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full ambient operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.
- 3.5 <u>Marking</u>. The part shall be marked with the PIN listed in 1.2 herein. Marking for device class M shall be in accordance with MIL-STD-883 (see 3.1 herein). In addition, the manufacturer's PIN may also be marked as listed in MIL-BUL-103. Marking for device classes B and S shall be in accordance with MIL-M-38510. Marking for device classes Q and V shall be in accordance with MIL-I-38535.
- 3.5.1 <u>Certification/compliance mark</u>. The compliance mark for device class M shall be a "C" as required in MIL-STD-883 (see 3.1 herein). The certification mark for device classes B and S shall be a "J" or "JAN" as required in MIL-M-38510. The certification mark for device classes Q and V shall be a "QML" as required in MIL-I-38535.
- 3.6 <u>Certificate of compliance</u>. For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.7.3 herein). For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.7.2 herein). The certificate of compliance submitted to DESC-EC prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device class M the requirements of MIL-STD-883 (see 3.1 herein), or for device classes Q and V, the requirements of MIL-I-38535 and the requirements herein.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-90800
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 4

DESC FORM 193A

JUL 91

TABLE I. <u>Electrical performance characteristics</u>.

Test	Symbol	Conditions	Group A	Limit	s	Unit
		$\begin{array}{c c} -55^{\circ}C \leq T_{A} \leq +125^{\circ}C \\ 4.5 \text{ V} \leq V_{CC} \leq 5.5 \text{ V} \\ \underline{\qquad} \text{unless otherwise specified} \end{array}$	subgroups	     Min	     Max	
Output high voltage	V <sub>OH</sub>	Conditions $-55^{\circ}C \le T_{A} \le +125^{\circ}C$ $4.5 \ V \le V_{CC} \le 5.5 \ V$ unless otherwise specified $ V_{CC} = 4.5 \ V, V_{IL} = 0.7 \ V,$ $ I_{OH} = -0.4 \ \text{mA},$ $ V_{IH} = 2.0 \ V$	1,2,3	2.5		٧
Output low voltage	v <sub>oL</sub>	V <sub>CC</sub> = 4.5 V, I <sub>OL</sub> = 4.0 mA	1,2,3		0.4	V
Input high current	I IH1	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 2.7 V	1,2,3	     	20	μΑ
	I IH2	V <sub>CC</sub> = 5.5 V,	1,2,3		0.1	mA
Input low current	IIL	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0.4 V	1,2,3	-0.06	-1.2	mA
Output short circuit current	Ios	v <sub>cc</sub> = 5.5 v, v <sub>out</sub> = 0.0 v 1/	1,2,3	-20	-100	   mA
Input clamp voltage	A <sup>IC</sup>	V <sub>CC</sub> = 4.5 V, I <sub>IN</sub> = -18 mA	1,2,3		-1.5	V
Power supply current	<sup>I</sup> cc	v <sub>cc</sub> = 5.5 v	1,2,3		65	mA
Functional tests		See 4.4.1b, V <sub>CC</sub> = 4.5 V, 5.5 V	7, 8			
Maximum clock frequency	f <sub>MAX</sub>		9	25		MHz
	+	-	10, 11	20	<del> </del>	ļ
Propagation de <u>la</u> y, CP to Qn or CC	t <sub>PLH</sub>	$V_{CC} = 5.0 \text{ V},$ $R_{L} = 2 \text{ k}\Omega$ $C_{L} = 50 \text{ pF}$	9 10,11	2.0	40 52	ns L
				<u> </u>	<del> </del>	
	<sup>t</sup> PHL		9	2.0	30	ns
			10,11	2.0	39	Ţ

See footnotes at end of table

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-90800
	i	REVISION LEVEL	SHEET 5

 $\label{thm:table_interpolation} \textbf{TABLE I.} \quad \underline{\textbf{Electrical performance characteristics}} \, - \, \textbf{Continued.}$ 

Test	Symbol	Conditions	Group A	Limi	ts	Unit
		-55°C ≤ T <sub>A</sub> ≤ +125°C 4.5 V ≤ V <sub>CC</sub> ≤ 5.5 V unless otherwise specified	subgroups	   <u>  Min</u>	Max	   
Setup time, S or D to CP	t <sub>s(H)</sub>	V <sub>CC</sub> = 5.0 V  R <sub>L</sub> = 2 κΩ  C <sub>L</sub> = 50 pF	9	5.0 		ns
		See figure 4	10,11	10		ns
	t <sub>s(L)</sub>		9	5.0		ns
			10,11	10		<u> </u>
Hold time, S or D to CP	t <sub>h(H)</sub>		9	5.0		ns
			10,11	10		7
	t <sub>h(L)</sub>		9	5.0		ns
			10,11	10		†
Clock pulse width	t <sub>w</sub> (H)		9	20		ns
		<u> </u>	10,11	25		†
	t <sub>w(L)</sub>		9	20		ns
			10,11	25	<del> </del>	1

 $<sup>\</sup>underline{1}$ / Not more than one output should be shorted at a time, and the duration should not exceed one second.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-90800
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 6
SC FORM 1024			

Case outlines	E and F
Terminal number	Terminal connection
1	QD
2	cc
3	QO
4	Q1
5	Q2
6	Q3
7	D
8	GND
9	CP
10	s
11	Q4
12	Q5
13	Q6
14	Q7
15	<u>Q</u> 7
16	v <sub>cc</sub>

Terminal connections

Pin names	Description
D	Serial data input
Š	Start input (active low)
СР	Clock pulse input (active rising edge)
QD	Synchronized serial data output
cc	Conversion complete output (active low)
QO - Q7	Parallel register outputs
Q7	Complement of Q7 output

Terminal descriptions

FIGURE 1. Terminal connections and descriptions.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-90800
		REVISION LEVEL	SHEET 7

	Input	ts	Outputs									
Time	i	1_	l	1				ļ				
t <sub>n</sub>	l D	s	QD	Q7 	Q6 	Q5 	Q4 	Q3	Q2 ]	Q1 	Q.O	cc
0	   x	   L	   <b>x</b>	   <b>x</b>	   X	   X	x	   x	X	   x	x	x
1	   D7	H	   X	   L	ί ∤ Η ,	   H	н	   H	   H	   H	н	H
_2	D6	   H	   b7	   D7	! <u>  L</u>	I <u> </u> н	н	<u> </u> <u> </u> н	 <u> </u> н	 <u> </u> н	Н	Н.
3	   D5	   H	   D6	   D7	   D6	   L	н	   н	   н	   н	H	H
4	   D4	   H	   D5	i   D7	   D6	   D5	L	   н	)   <b>H</b> 	¦   н	н	 
5	D3	   H	   D4 	   D7	!   D6	   D5	D4	   L	!   H	   H	Н	H
6	D2	і <u> </u> н	D3	D7	   D6	   D5	D4	D3	L	   <b>H</b>	H	   H
7	   D1	   H 	   D2	   D7	   D6	   D5	D4	   D3	D2	   L	   H	   H
8	DO	H	D1	D7	   D6	D5	D4	   D3	1   D2	   D1	L	 
9	[ X	H	DO	   D7	   D6	   D5	D4	   D3	D2	   D1	   100	   L
10	X	   H	i   X 	   D7	   <b>D6</b> 	   <b>D5</b>	D4	   D3 	D2	   D1	   DO	   L

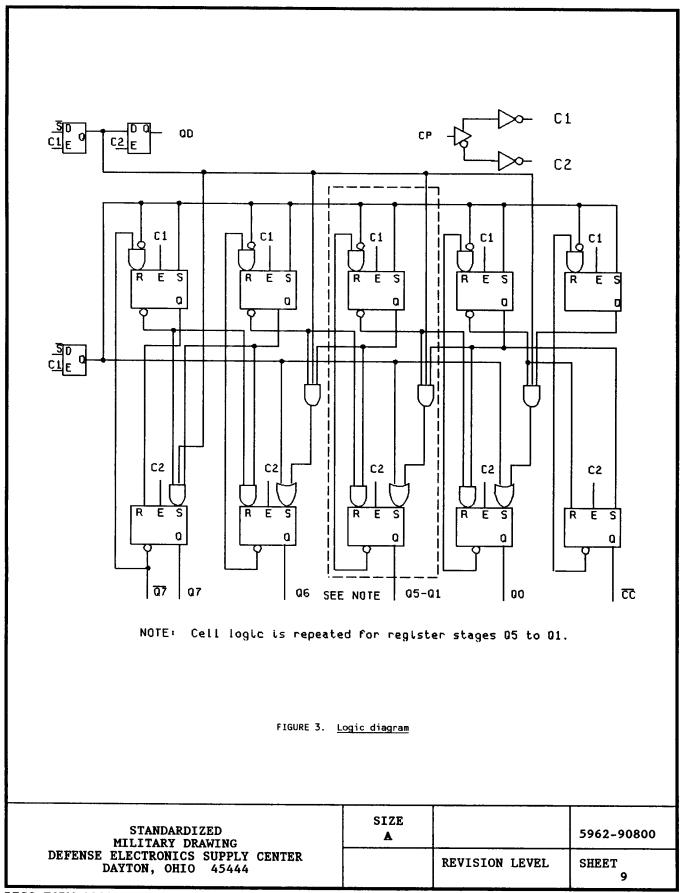
H = High voltage level

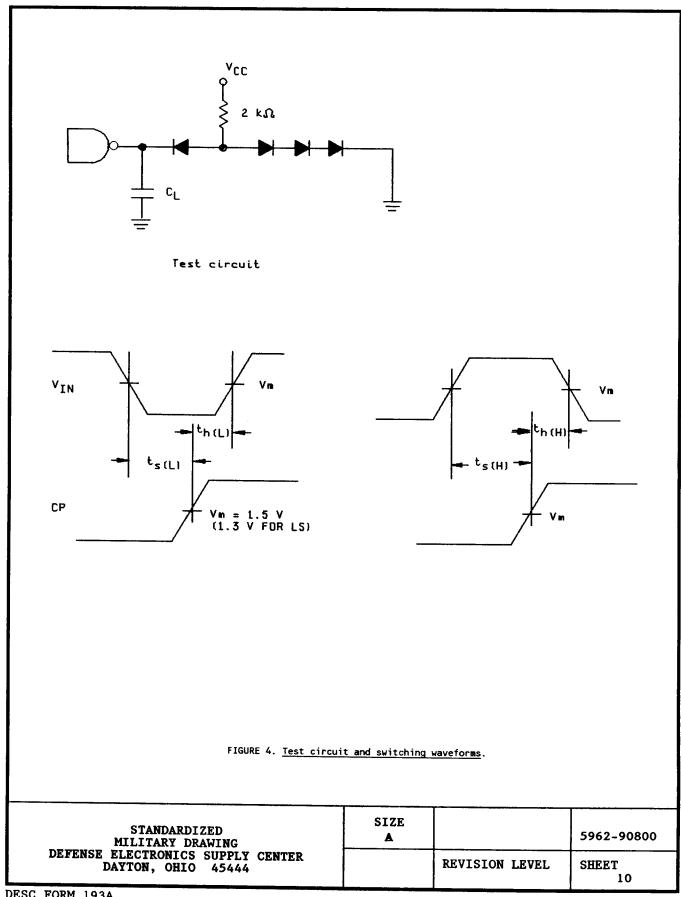
L = Low voltage level

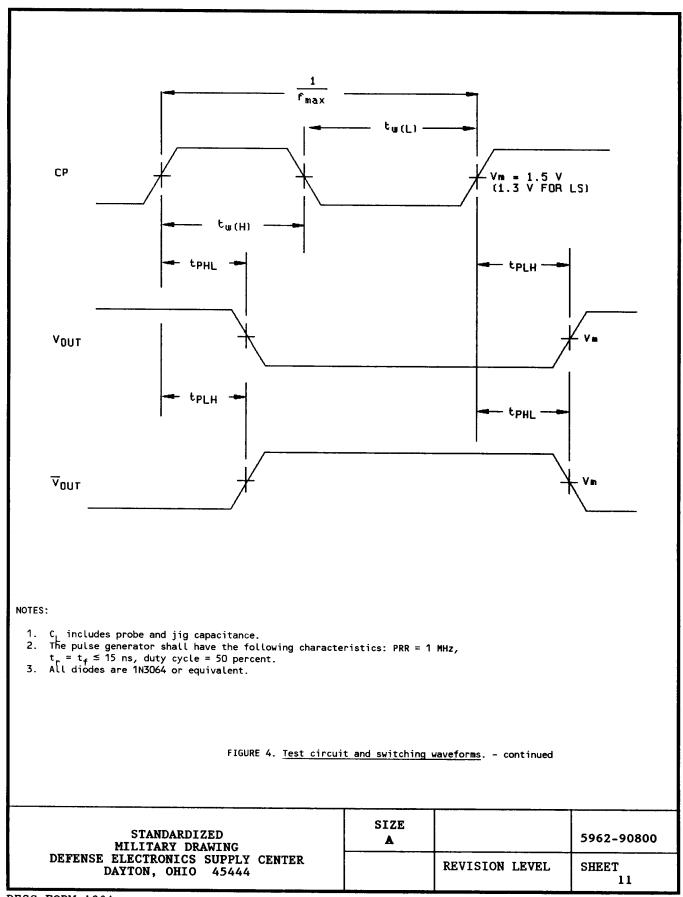
X = Immaterial

FIGURE 2. Truth table.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-90800
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 8







- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required for device class M in MIL-STD-883 (see 3.1 herein) or device classes B and S in MIL-M-38510 or for device classes Q and V in MIL-I-38535 shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 <u>Notification of change for device class M</u>. For device class M, notification to DESC-EC of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change as defined in MIL-STD-480.
- 3.9 <u>Verification and review for device class M</u>. For device class M, DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
- 3.10 <u>Microcircuit group assignment for device classes M, B, and S</u>. Device classes M, B, and S devices covered by this drawing shall be in microcircuit group number 12 (see MIL-M-38510, appendix E).
- 3.11 <u>Serialization for device class S</u>. All device class S devices shall be serialized in accordance with MIL-M-38510.
  - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. For device class M, sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein). For device classes B and S, sampling and inspection procedures shall be in accordance with MIL-M-38510 and method 5005 of MIL-STD-883, except as modified herein. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-I-38535 and the device manufacturer's QM plan.
- 4.2 <u>Screening</u>. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. For device classes B and S, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to qualification and quality conformance inspection. For device classes Q and V, screening shall be in accordance with MIL-I-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection.
  - 4.2.1 Additional criteria for device classes M, B, and S.
    - a. Burn-in test, method 1015 of MIL-STD-883.
      - (1) Test condition A, B, C, or D. For device class M, the test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. For device classes B and S, the test circuit shall be submitted to the qualifying activity. For device classes N, B, and S, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.
        - (2)  $T_A = +125$ °C, minimum.
    - b. Interim and final electrical test parameters shall be as specified in table II herein.
  - 4.2.2 Additional criteria for device classes Q and V.
    - a. The burn-in test duration, test condition and test temperature or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-I-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-I-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.
    - b. Interim and final electrical test parameters shall be as specified in table II herein.
    - c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in appendix B of MIL-I-38535.
  - 4.3 Qualification inspection.
- 4.3.1 <u>Qualification inspection for device classes B and S</u>. Qualification inspection for device classes B and S shall be in accordance with MIL-M-38510. Inspections to be performed shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5).

STANDARDIZED MILITARY DRAWING	SIZE A		5962-90800
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 12

TABLE II. Electrical test requirements.

Test requirements		Subgroups dance with M nod 5005, tab	Subgroups (in accordance with MIL-I-38535, table III)		
	Device class M	Device class B	Device class S	Device class Q	Device class V
Interim electrical parameters (see 4.2)			1,7		1,7
Final electrical parameters (see 4.2)	1,2,3,7, 8,9 <u>1</u> /	1,2,3,7, 8,9,10,11 <u>2</u> /	1,2,3,7, 8,9,10,11 <u>2</u> /	1,2,3,7, 8,9,10,11 <u>1</u> /	1,2,3,7, 8,9,10,11 <u>1</u> /
Group A test requirements (see 4.4)	1,2,3,7, 8,9,10* 11*	1,2,3,7, 8,9,10,11	1,2,3,7, 8,9,10,11	1,2,3,7, 8,9,10,11	1,2,3,7, 8,9,10,11
Group B end-point electrical parameters (see 4.4)			1,2,3,7, 8,9,10,11		
Group C end-point electrical parameters (see 4.4)	1,2,3	1,2,3,7, 8,9,10,11		1,2,3,7, 8,9,10,11	1,2,3,7 8,9,10,11
Group D end-point electrical parameters (see 4.4)	1,2,3	1,2,3,7, 8,9,10,11	1,2,3,7, 8,9,10,11	1,2,3,7, 8,9,10,11	1,2,3,7, 8,9,10,11
Group E end-point electrical parameters (see 4.4)	1,7,9	1,7,9	1,7,9	1,7,9	1,7,9

<sup>1/</sup> PDA applies to subgroup 1.

- 4.3.2 Qualification inspection for device classes Q and V. Qualification inspection for device classes Q and V shall be in accordance with MIL-I-38535. Inspections to be performed shall be those specified in MIL-I-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5).
- 4.4 Conformance inspection. Quality conformance inspection for device class M shall be in accordance with MIL-STD-883 (see 3.1 herein) and as specified herein. Quality conformance inspection for device classes B and S shall be in accordance with MIL-M-38510 and as specified herein. Inspections to be performed for device classes M, B, and S shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5). Technology conformance inspection for classes Q and V shall be in accordance with MIL-I-38535 including groups A, B, C, D, and E inspections and as specified herein except where option 2 of MIL-I-38535 permits alternate in-line control testing.

## 4.4.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. For device class M, subgroups 7 and 8 tests shall be sufficient to verify the truth table. For device classes B and S, subgroups 7 and 8 tests shall be sufficient to verify the truth table as approved by the qualifying activity. For device classes Q and V, subgroups 7 and 8 shall include verifying the functionality of the device; these tests shall have been fault graded in accordance with MIL-STD-883, test method 5012 (see 1.5 herein).
- 4.4.2 Group B inspection. The group B inspection end-point electrical parameters shall be as specified in table II herein. For device class S steady-state life tests, the test circuit shall be submitted to the qualifying activity.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-90800
		REVISION LEVEL	SHEET 13

PDA applies to subgroups 1 and 7.
 Subgroups 10 and 11 if not tested, shall be guaranteed to the limits specified in table I.

- 4.4.3 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table II herein.
- 4.4.3.1 Additional criteria for device classes M, B, and S. Steady-state life test conditions, method 1005 of MIL-STD-883:
  - a. Test condition A, B, C or D. For device class M, the test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. For device class B, the test circuit shall be submitted to the qualifying activity. For device classes M and B, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005.
  - b.  $T_A = +125$ °C, minimum.
  - c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.
- 4.4.3.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-I-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-I-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005.
- 4.4.4 <u>Group D inspection</u>. The group D inspection end-point electrical parameters shall be as specified in table II herein.
- 4.4.5 <u>Group E inspection</u>. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein). RHA levels for device classes B, S, Q, and V shall be M, D, R, and H and for device class M shall be M and D.
  - a. End-point electrical parameters shall be as specified in table II herein.
  - b. For device classes M, B, and S, the devices shall be subjected to radiation hardness assured tests as specified in MIL-M-38510 for RHA level being tested. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-I-38535 for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at  $T_A = +25^{\circ}\text{C}$  ±5°C, after exposure, to the subgroups specified in table II herein.
  - c. When specified in the purchase order or contract, a copy of the RHA delta limits shall be supplied.
  - 5. PACKAGING
- 5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-M-38510 for device classes M, B, and S and MIL-I-38535 for device classes Q and V.
  - 6. NOTES
- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.1.1 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
  - 6.1.2 Substitutability. Device classes B and Q devices will replace device class M devices.
- 6.2 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).
- 6.3 <u>Record of users</u>. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and which SMD's are applicable to that system. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DESC-EC, telephone (513) 296-6047.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-90800
		REVISION LEVEL	SHEET 14

- 6.4 <u>Comments</u>. Comments on this drawing should be directed to DESC-EC, Dayton, Ohio 45444, or telephone (513) 296-8525.
- 6.5 <u>Symbols, definitions, and functional descriptions</u>. The abbreviations, symbols, and definitions used herein are defined in MIL-M-38510 and MIL-STD-1331.
- 6.6 One part one part number system. The one part one part number system described below has been developed to allow for transitions between identical generic devices covered by the four major microcircuit requirements documents (MIL-M-38510, MIL-H-38534, MIL-I-38535, and 1.2.1 of MIL-STD-883) without the necessity for the generation of unique PIN's. The four military requirements documents represent different class levels, and previously when a device manufacturer upgraded military product from one class level to another, the benefits of the upgraded product were unavailable to the Original Equipment Manufacturer (OEM), that was contractually locked into the original unique PIN. By establishing a one part number system covering all four documents, the OEM can acquire to the highest class level available for a given generic device to meet system needs without modifying the original contract parts selection criteria.

Military documentation format	Example PIN under new system	Manufacturing source listing	Document <u>listing</u>
New MIL-M-38510 Military Detail Specifications (in the SMD format)	5962-XXXXXZZ(B or S)YY	QPL-38510 (Part 1 or 2)	MIL-BUL-103
New MIL-H-38534 Standardized Military Drawings	5962-XXXXXZZ(H or K)YY	QML-38534	MIL-BUL-103
New MIL-I-38535 Standardized Military Drawings	5962-XXXXXZZ(Q or V)YY	QML-38535	MIL-BUL-103
New 1.2.1 of MIL-STD-883 Standardized Military Drawings	5962-XXXXXZZ(M)YY	MIL-BUL-103	MIL-BUL-103

- 6.7 Sources of supply.
- 6.7.1 <u>Sources of supply for device classes B and S</u>. Sources of supply for device classes B and S are listed in QPL-38510.
- 6.7.2 Sources of supply for device classes Q and V. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DESC-EC and have agreed to this drawing.
- 6.7.3 Approved sources of supply for device class M. Approved sources of supply for class M are listed in MIL-BUL-103. The vendors listed in MIL-BUL-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-EC.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-90800
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 15